



# UM10780

TEA1721ADB1102 GreenChip 5 W QBIC demo board

Rev. 1 — 7 May 2014

User manual

## Document information

Info	Content
<b>Keywords</b>	TEA1721AT, ultra-low standby power, constant output voltage, constant output current, primary sensing, integrated high-voltage switch, integrated high-voltage start-up, USB charger, 5 V/1 A supply
<b>Abstract</b>	This user manual describes a 5 W Constant Voltage (CV) or Constant Current (CC) universal input power supply for mobile phone adapters and chargers. The TEA1721ADB1102 demo board is based on the GreenChip SP TEA1721AT. GreenChip SP TEA1721AT enables low no-load power consumption <10 mW. The TEA1721AT design ensures a low external component count for cost-effective applications. In addition, the TEA1721AT provides advanced control modes for optimal performance. The TEA1721AT integrates the 700 V power MOSFET switch and SMPS controller.



## Revision history

Rev	Date	Description
v.1	20140507	first issue

## Contact information

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: [salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)

## 1. Introduction

**WARNING**

**Lethal voltage and fire ignition hazard**



The non-insulated high voltages that are present when operating this product, constitute a risk of electric shock, personal injury, death and/or ignition of fire.

This product is intended for evaluation purposes only. It shall be operated in a designated test area by personnel qualified according to local requirements and labor laws to work with non-insulated mains voltages and high-voltage circuits. This product shall never be operated unattended.

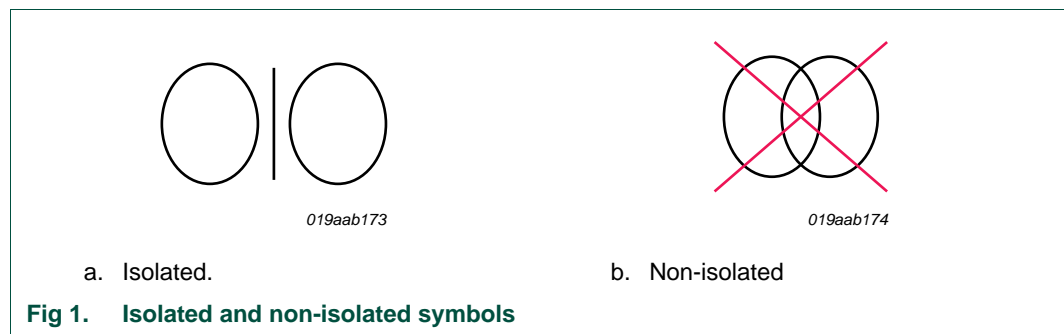
This User Manual describes a 5 W Constant Voltage (CV) or Constant Current (CC) universal input power supply for mobile phone adapters and chargers. The TEA1721ADB1102 demo board is based on the TEA1721AT GreenChip SP.

The TEA1721AT GreenChip SP provides ultra-low < 10 mW, no-load power consumption without using additional external components. Designs are cost-effective using the TEA1721AT GreenChip SP because only a few external components are needed in a typical application. In addition, the TEA1721AT provides advanced control modes for optimal performance. The TEA1721AT integrates the 700 V power MOSFET switch and SMPS controller.

**Remark:** All voltages are in V (AC) unless otherwise stated

## 2. Safety warning

The complete demo board application is AC mains voltage powered. Avoid touching the board when power is applied. An isolated housing is obligatory when used in uncontrolled, non-laboratory environments. Always provide galvanic isolation of the mains phase using a variable transformer. The following symbols identify isolated and non-isolated devices.



### 3. Features

- Enables low no-load power dissipation <10 mW
- Low component count for a cost-effective design
- Advanced control modes for optimal performance
- SMPS controller with integrated power MOSFET switch
- 700 V high-voltage power switch for global mains operation
- Primary sensing at end-of-conduction for accurate output voltage control
- Avoids audible noise in all operation modes
- Compensation of cable impedance included
- Jitter function for reduced EMI
- USB battery charging and Energy Star compliant
- Universal mains input
- Isolated output
- Highly efficient: > 76 %
- OverTemperature Protection (OTP)

### 4. Technical specification

Table 1. Input and output specification

Parameter	Condition	Value	Remark
<b>Input</b>			
input voltage	-	90 V to 265 V	universal AC mains
input frequency	-	47 Hz to 63 Hz	
average power dissipation	no-load	< 10 mW	
<b>Output</b>			
output voltage	-	5.0 V	-
maximum output current	-	1.0 A	-
maximum output power	-	5.0 W	-

## 5. Board photograph



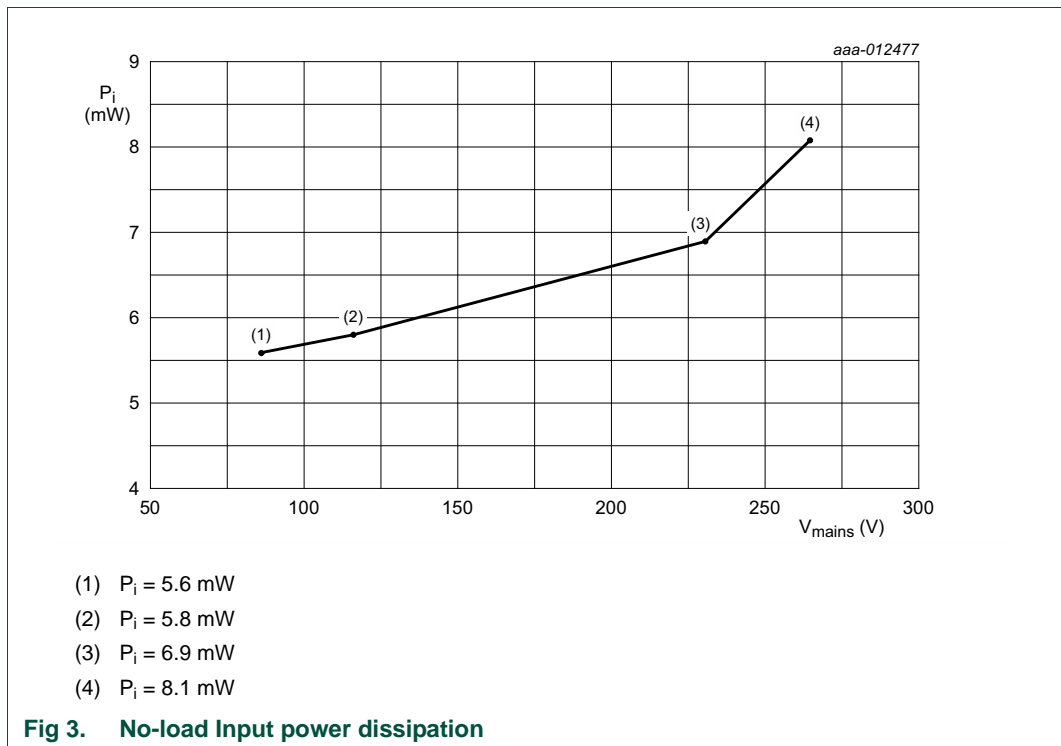
## 6. Performance

### 6.1 No-load input power dissipation

Table 2. No-load Input power dissipation<sup>[1]</sup>

Output voltage	Conditions	Power dissipation	Unit
5.16 V	115 V; 60 Hz	5.8	mW
5.14 V	230 V; 50 Hz	6.9	mW

[1] The no-load input power has been measured after 20 minutes temperature stabilization time.



### 6.2 Output voltage and efficiency performance data

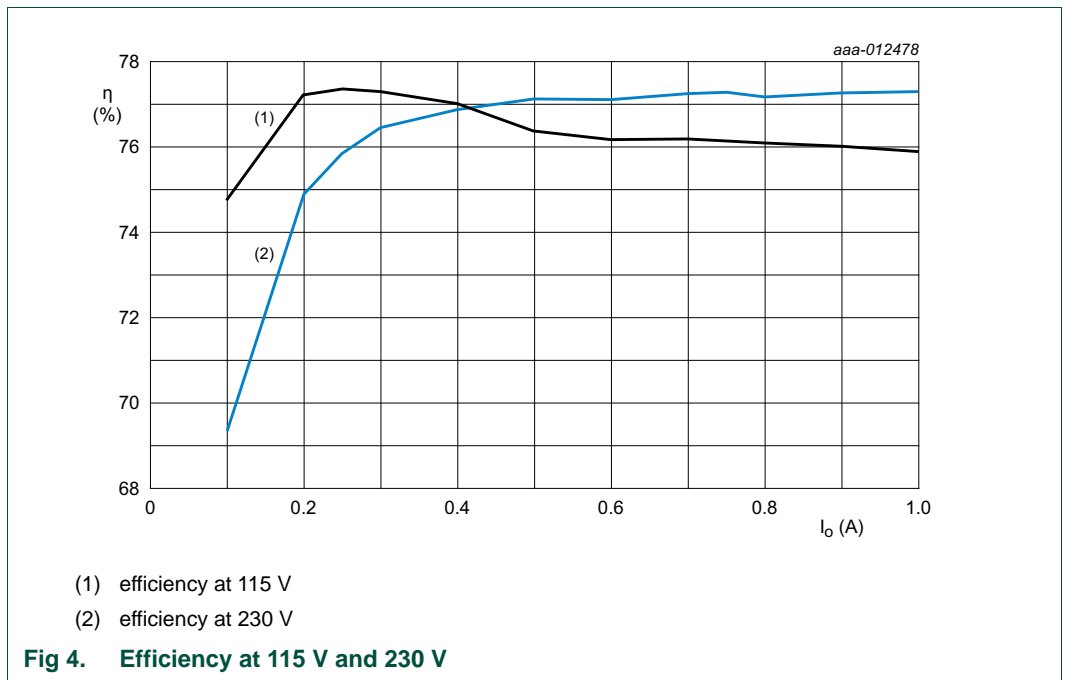
Table 3 and Figure 4 show the measured efficiency figures and VI characteristics of the GreenChip SP TEA1721AT demo board. The efficiency and VI characteristics have been measured after 20 minutes temperature stabilization time.

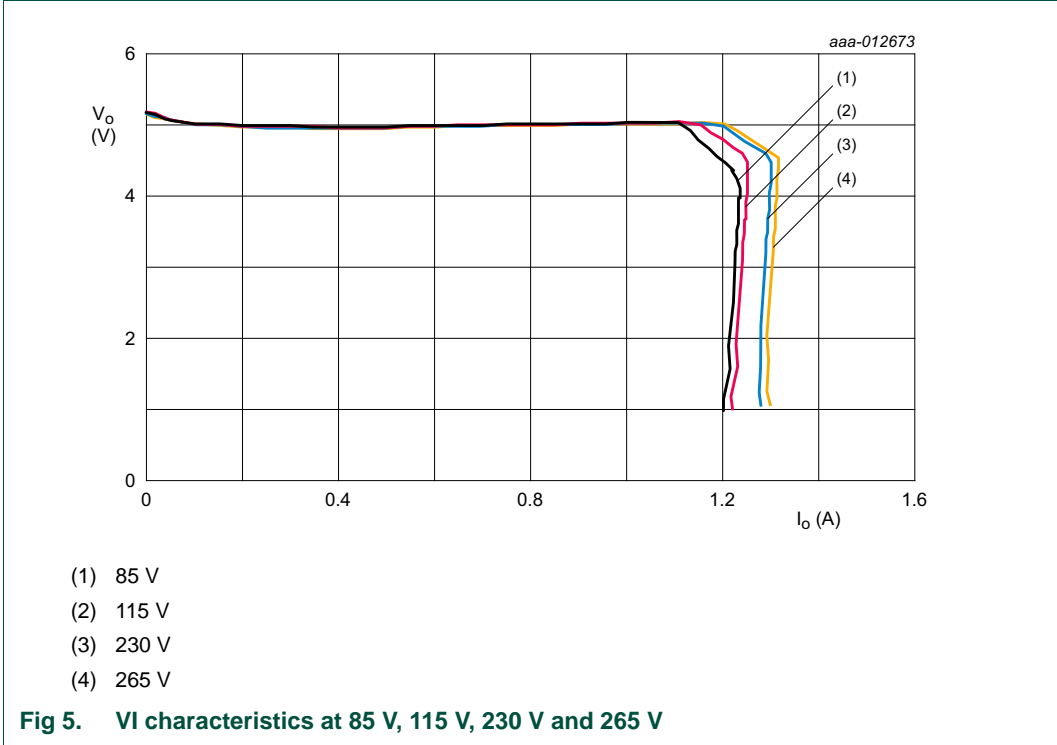
Table 3. Efficiency and VI characteristics

V <sub>CC</sub>	Parameter	Values									
115 V/60 Hz	output current (A)	0.000	0.010	0.020	0.030	0.050	0.100	0.250	0.500	0.750	1.000
	output voltage (V)	5.16	5.14	5.12	5.09	5.06	5.00	4.98	4.97	5.01	5.03
	output power (W)	0.000	0.052	0.102	0.152	0.253	0.500	1.245	2.483	3.754	5.030
	input power (W)	0.0058	0.097	0.182	0.244	0.366	0.669	1.609	3.252	4.929	6.625
	efficiency (%)	-	-	-	-	-	74.8	77.4	77.4	76.2	75.9

Table 3. Efficiency and VI characteristics ...continued

V <sub>CC</sub>	Parameter	Values									
230 V/50 Hz	output current (A)	0.000	0.010	0.020	0.030	0.050	0.100	0.250	0.500	0.750	1.000
	output voltage (V)	5.14	5.11	5.10	5.09	5.06	5.00	4.97	4.95	5.00	5.02
	output power	0	0.051	0.101	0.152	0.253	0.500	1.242	2.473	3.746	5.020
	input power (W)	0.0067	0.111	0.210	0.299	0.423	0.721	1.635	3.205	4.848	6.494
	efficiency (%)	-	-	-	-	-	69.3	75.9	77.2	77.3	77.3

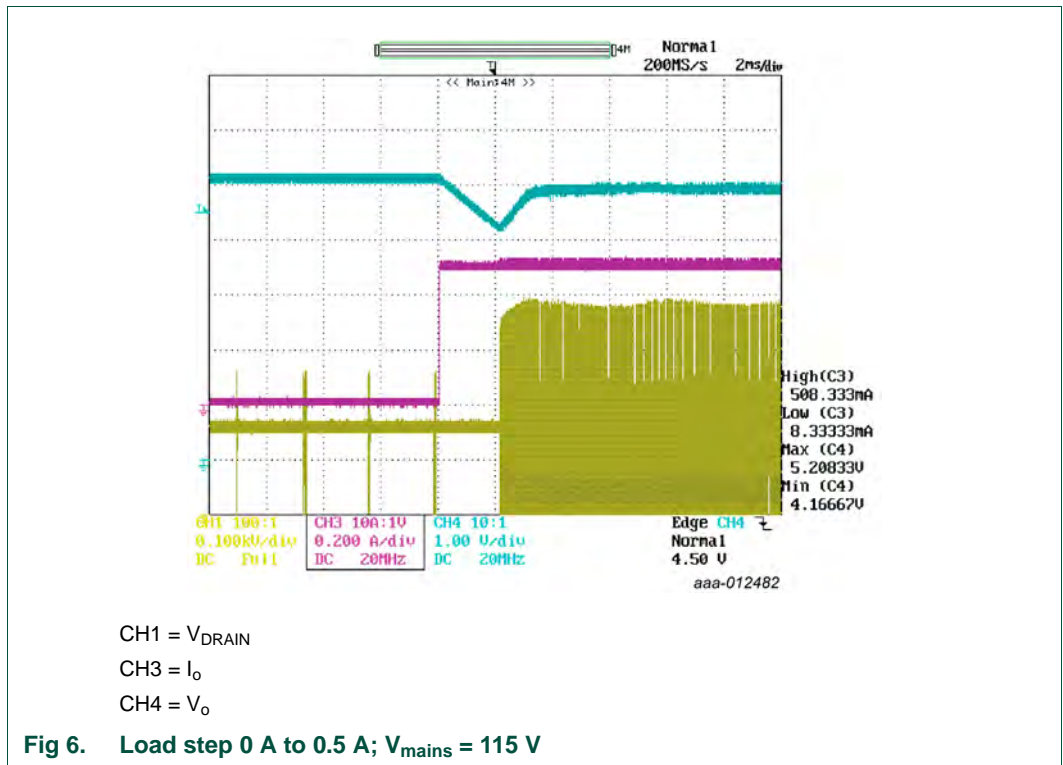






### 6.3 Dynamic loading from 0 A to 0.5 A

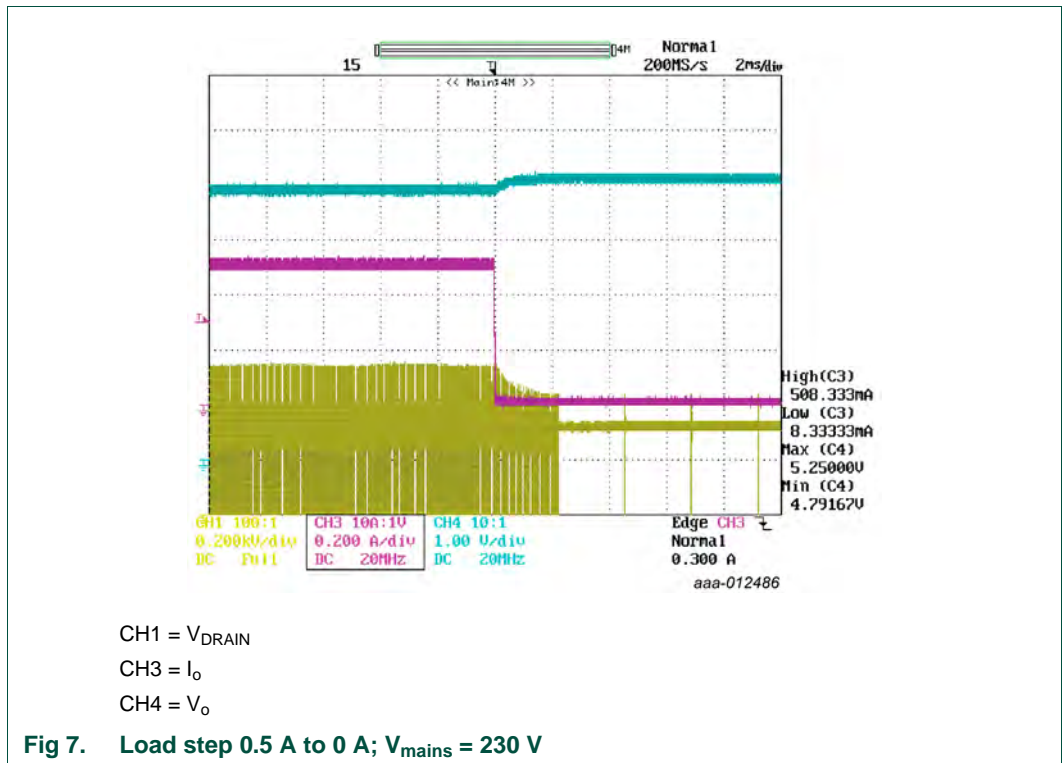
The dynamic loading was tested according to the USB-charger specification 1.1. At a load step of 0 A to 0.5 A, the output voltage must stay above 4.1 V. Due to primary sensing, the TEA1721AT detects the load step only after the next switching cycle. The load step is measured at  $V_{mains} = 115\text{ V}$ .



In the worst case (see [Figure 6](#)), the output voltage drops to 4.17 V which fulfills the USB-charger specification 1.1.

6.4 Dynamic loading from 0.5 A to 0 A

The dynamic loading was tested according to the USB-charger specification 1.1. At a load step of 0.5 A to 0 A, the output voltage must stay below 6.0 V. Due to primary sensing, the TEA1721AT detects the load step only after the next switching cycle. The load step is measured at  $V_{mains} = 230\text{ V}$ .



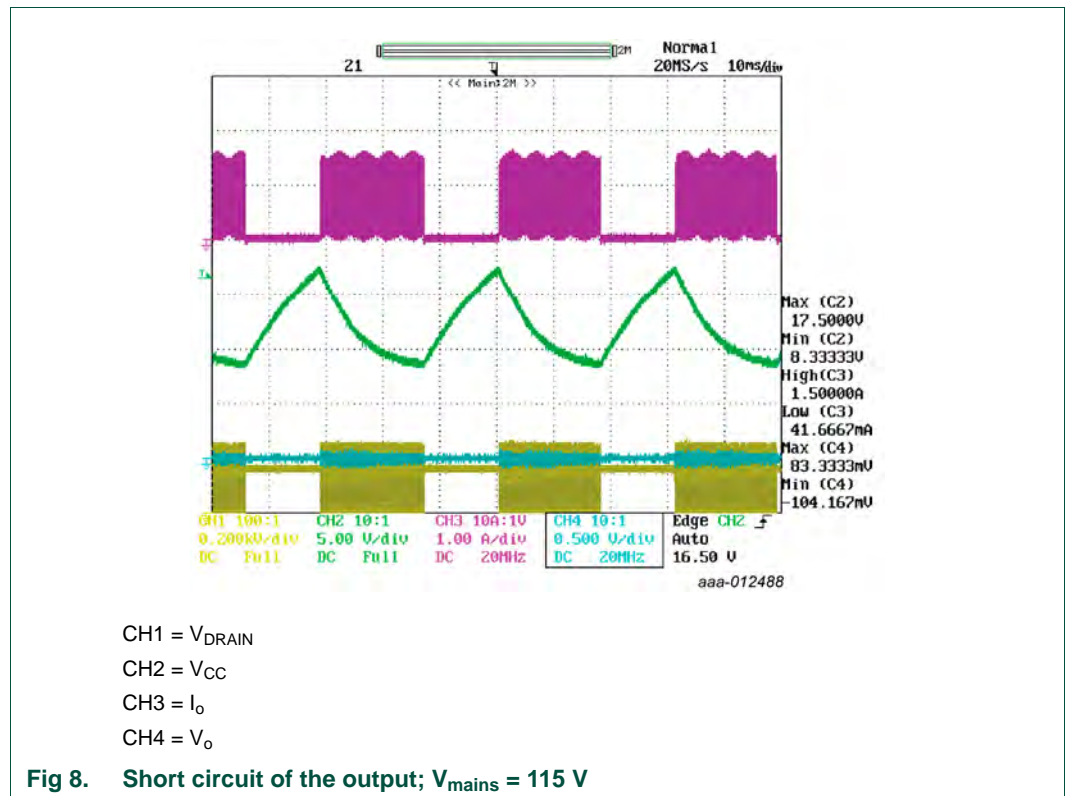
After the load step from 0.5 A to 0 A, the output voltage rises from 4.8 V to 5.25 V.

### 6.5 Short-circuit of the output

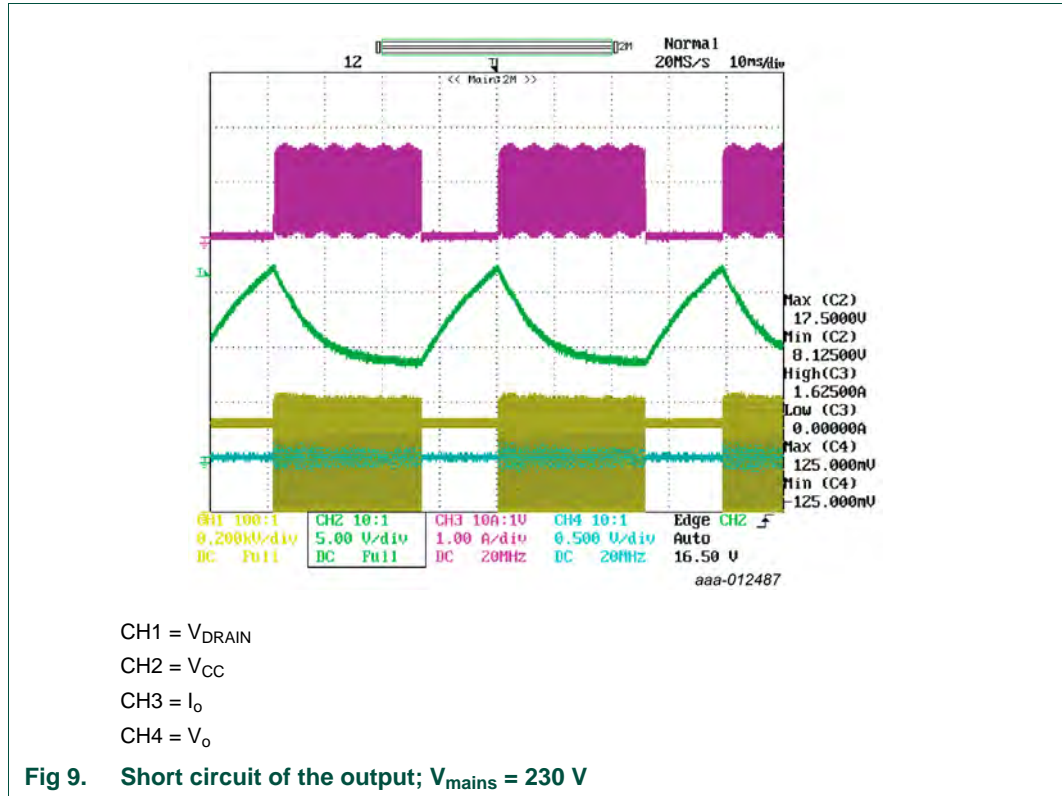
The output of the demo board can be short-circuited without damaging of any component.

Figure 8 shows the behavior of the converter when the output is short-circuited. During short-circuit of the output, the  $V_{CC}$  voltage (CH3) switches between  $V_{CC(startup)}$  (17 V) and  $V_{CC(stop)}$  (8 V) level.

At 115 V the average output current during short circuit is 470 mA. The input power is 0.32 W.



At 230 V, the average output current during a short circuit is 610 mA. The input power is 0.44 W.



### 6.6 Output voltage ripple performance

The output voltage ripple was measured with an oscilloscope probe connected to the output of the demo board. A probe tip was used with a very small GND connection. A 100 nF capacitor between output voltage and GND was used to reduce high frequency noise. The output voltage ripple was measured at full load and at  $V_{mains}$  of 115 V and 230 V.

Figure 10 shows the output voltage ripple at  $V_{mains} = 115$  V. The output ripple voltage is 72 mV using output capacitors C6, C8 and C10 as specified in the Bill Of Materials (BOM).

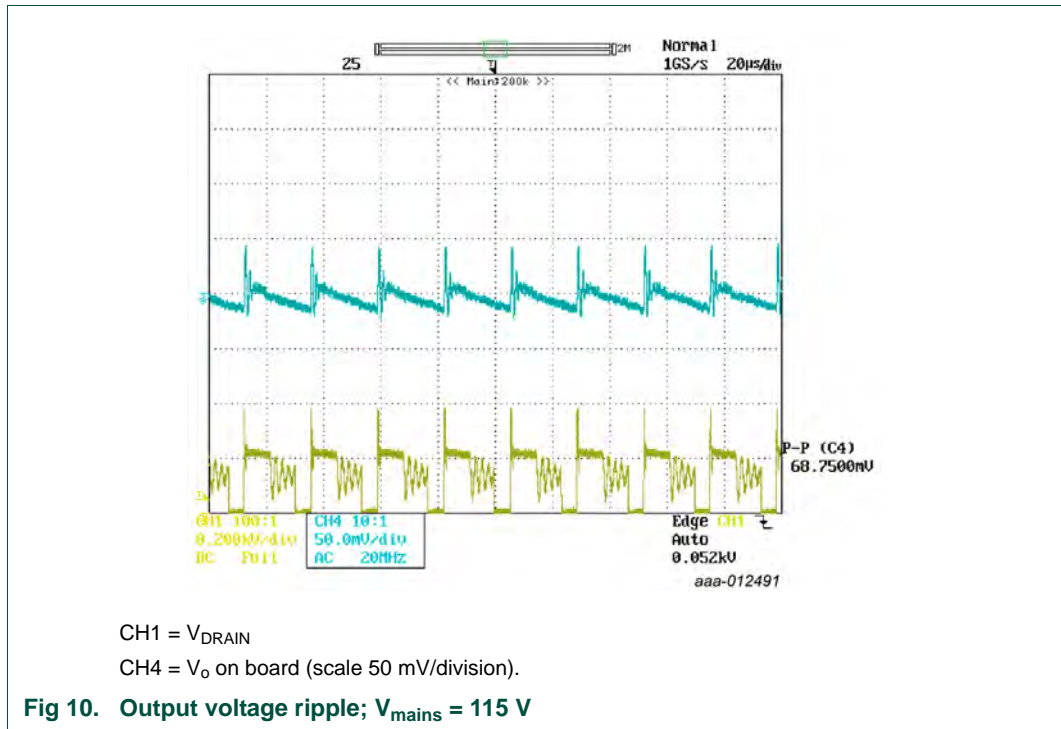
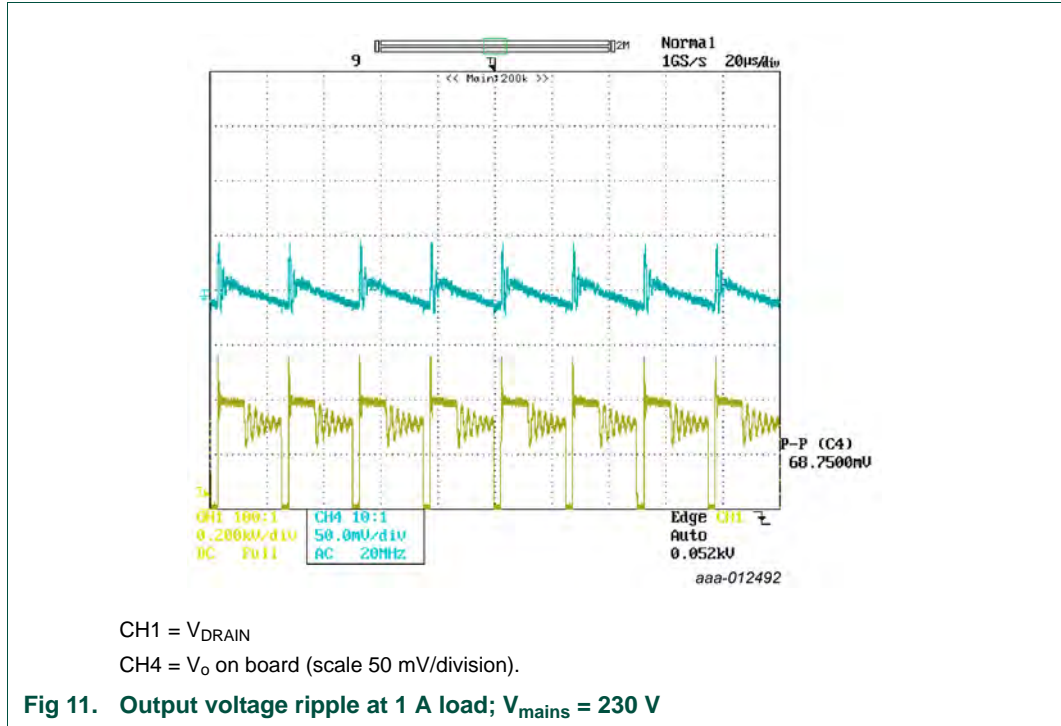
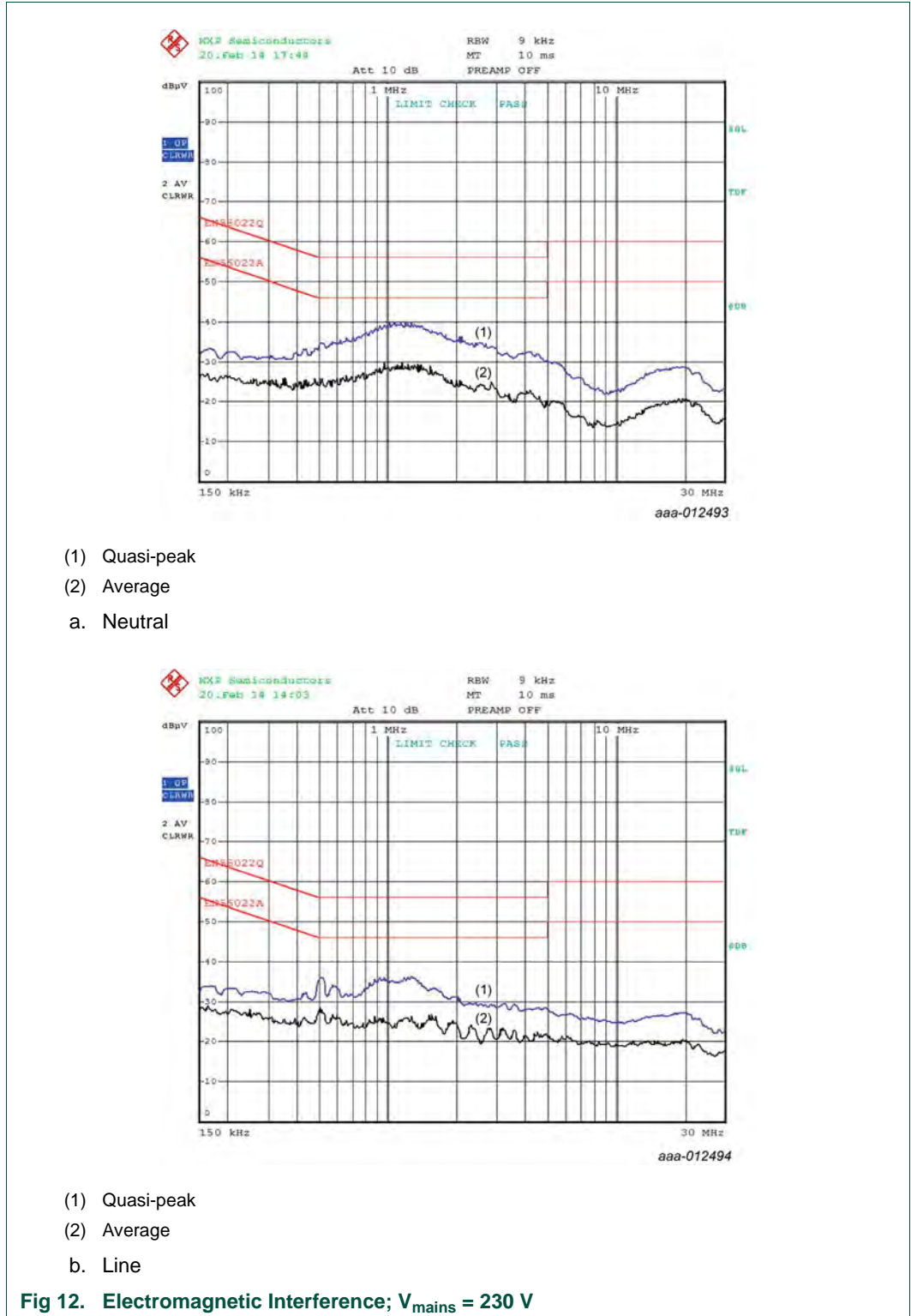


Figure 11 shows the output voltage ripple at a 1 A load at 230 V. The output ripple voltage is 69 mV using output capacitors C6, C8 and C10 as specified in the Bill Of Materials (BOM).

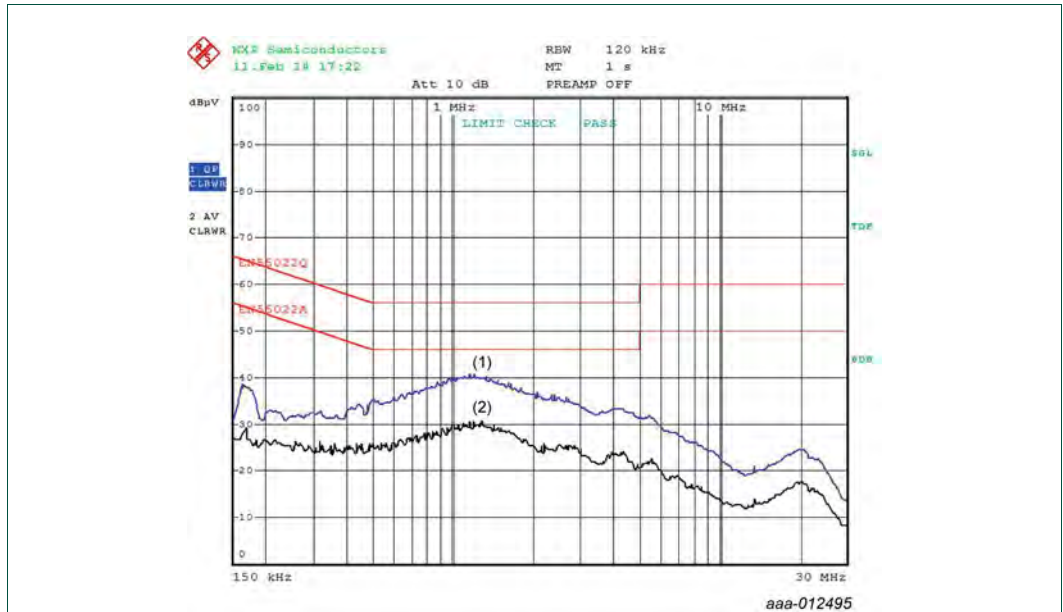


6.7 Conducted EMI measurement results

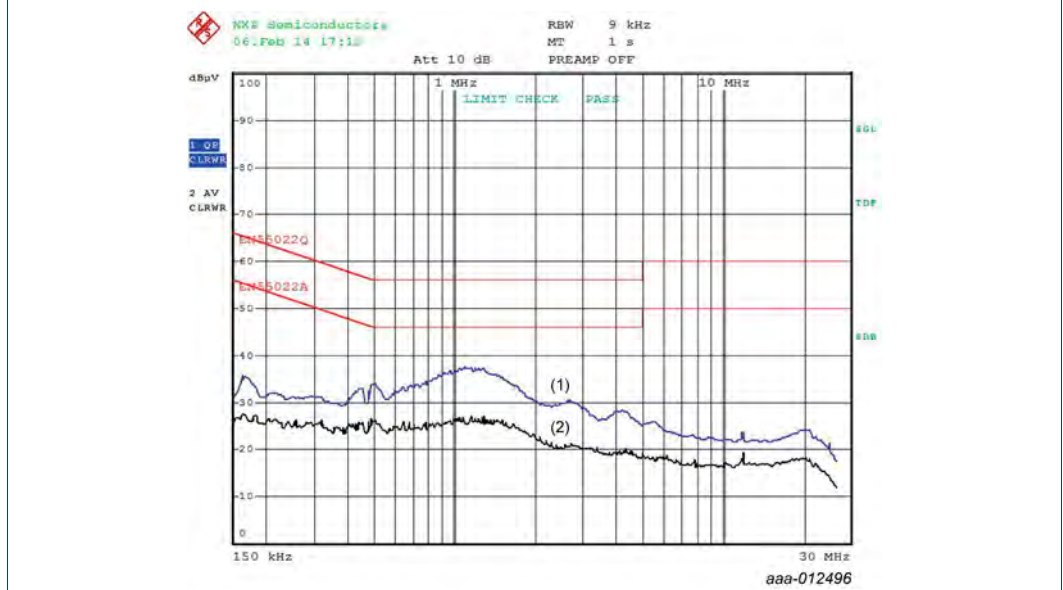
The conducted EMI is measured according to CISPR22, with a 5 Ω load at the end of a 1m USB cable. EMI is measured on neutral and on line at  $V_{mains} = 230$  V. The frequency range is 150 kHz to 30 MHz.







- (1) Quasi-peak
- (2) Average
- a. Neutral



- (1) Quasi-peak
- (2) Average
- b. Line

Fig 13. Electromagnetic Interference;  $V_{mains} = 115 V$



## 7. Schematic

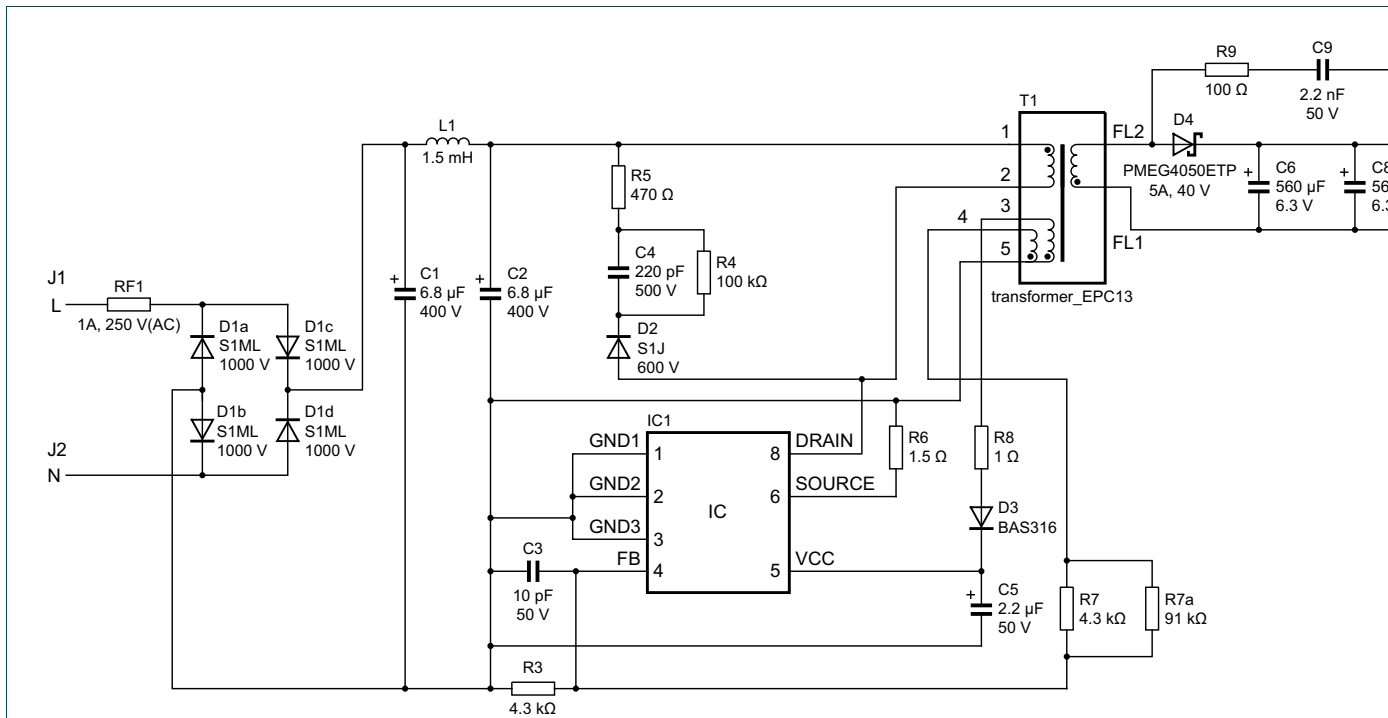


Fig 14. TEA1721AT 5 W schematic

## 8. Bill of Materials (BOM)

Table 4. TEA1721ADB1102 bill of material

Reference	Description and values	Part number	Manufacturer
C1; C2	capacitor; 6.8 $\mu$ F; 400 V; 8 $\times$ 10.8 mm	AX series	Rubycon
C3	capacitor; 10 pF; 50 V; X7R; C0603	-	-
C4	capacitor; 220 pF; 500 V; C0805	CC0805JRNPOBBN221	Yageo
C5	2.2 $\mu$ F; 50 V; C0805	C2012X7R1H225K	TDK
C6; C8	560 $\mu$ F; 6.3 V; 6.3 $\times$ 8 mm	RS80J561MDN1JT	Nichicon
C7	capacitor; not mounted	-	-
C9	capacitor; 2.2 nF; 50 V; X7R; C0603	-	-
C10	capacitor; 22 $\mu$ F; 10 V; 1206	GRM31CR71A226KE15L	Murata
D1a; D1b; D1c; D1d	diode; S1ML; 1000 V; sub-SMA	S1ML	Taiwan Semiconductor
D2	diode; S1JL; 600 V; sub-SMA	S1JL	Taiwan Semiconductor
D3	diode; BAS316; 100 V; SOD323	BAS316	NXP Semiconductors
D4	diode; PMEG4050ETP; 40 V; SOD128	PMEG4050ETP	NXP Semiconductors
IC1	TEA1721AT; 700 V; SO7	TEA1721AT/N1	NXP Semiconductors
J1; J2	connector; input pin	SN/040/LT SILVER	Oxley Group
J3	connector	USB AF DIP -094-H	Gold Conn
L1	inductor; 1.5 mH	ZAL-0512-152K	Zenith-Tek
R3; R7	resistor; 4.3 k $\Omega$ ; 1 %; 0603	-	-
R4	resistor; 100 k $\Omega$ ; 0805	-	-
R5	resistor; 470 $\Omega$ ; 250 mW; 1206	-	-
R6	resistor; 1.5 $\Omega$ ; 1 %; 1206	-	-
R7a	resistor; 91 k $\Omega$ ; 1 %; 0603	-	-
R8	resistor; 1 $\Omega$ ; 0603	-	-
R9	resistor; 100 $\Omega$ ; 0603	-	-
R10	resistor; 16 k $\Omega$ ; 0603	-	-
RF1	Fusistor; 1 A; 250 V (AC); 3.18 $\times$ 7.6 mm	MCPMP 1A 250V	Multicomp
T1	transformer; EPC13	750313567	Würth Elektronik

## 9. Circuit description

The GreenChip SP TEA1721AT demo board consists of a single-phase full-wave rectifier circuit, a filtering section, a switching section, an output section and a feedback section. [Figure 14](#) shows the circuit diagram. [Table 4](#) shows the component list.

### 9.1 Rectification section

The bridge diodes D1a to D1d form the single-phase full-wave rectifier. Capacitors C1 and C2 are reservoir capacitors for the rectified input voltage. Resistor RF1 limits inrush current and acts as a fuse. Terminals J1 and J2 connect the input to the electricity utility network. Swapping these two wires has no effect on the operation of the converter.

### 9.2 Filtering section

Inductor L1, with capacitors C1 and C2, form a filter to attenuate conducted differential mode EMI noise.

### 9.3 GreenChip SP section

The TEA1721AT device (IC1) contains the power MOS switch, oscillator, CV/CC, start-up control and protection functions all in one IC. Its integrated 700 V MOSFET allows sufficient voltage margins in universal input AC applications, including line surges. The auxiliary windings on transformer T1 generate the supply voltage and primary sensing information for the TEA1721AT. Diode D3 and capacitor C5 half-wave rectify the voltage. Capacitor C5 is charged via the current limiter resistor R8. The voltage on capacitor C5 is the supply voltage for the VCC pin.

The RCD-R clamp consisting of R4, C4, D2 and R5 limits drain voltage spikes caused by leakage inductance of the transformer.

### 9.4 Output section

Diode D4 is a Schottky barrier type diode and capacitors C6/C8 rectify the voltage from secondary winding of transformer T1. Using a Schottky barrier type diode results in a high efficiency of the demo board. Capacitors C6, C8, and C10 must have sufficient low ESR characteristics to meet the output voltage ripple requirement without adding an LC post filter. Resistor R9 and capacitor C9 dampen high frequency ringing and reduce the voltage stress on diode D4. Resistor R10 provides a minimum load to maintain output control in no-load condition.

### 9.5 Feedback section

The TEA1721AT controls the output by current and frequency control for CV and CC regulation. The auxiliary feedback winding on Transformer T1 senses the output voltage. The FB pin senses the reflected output voltage using feedback resistors Rfb1 and Rfb2.

10. PCB layout

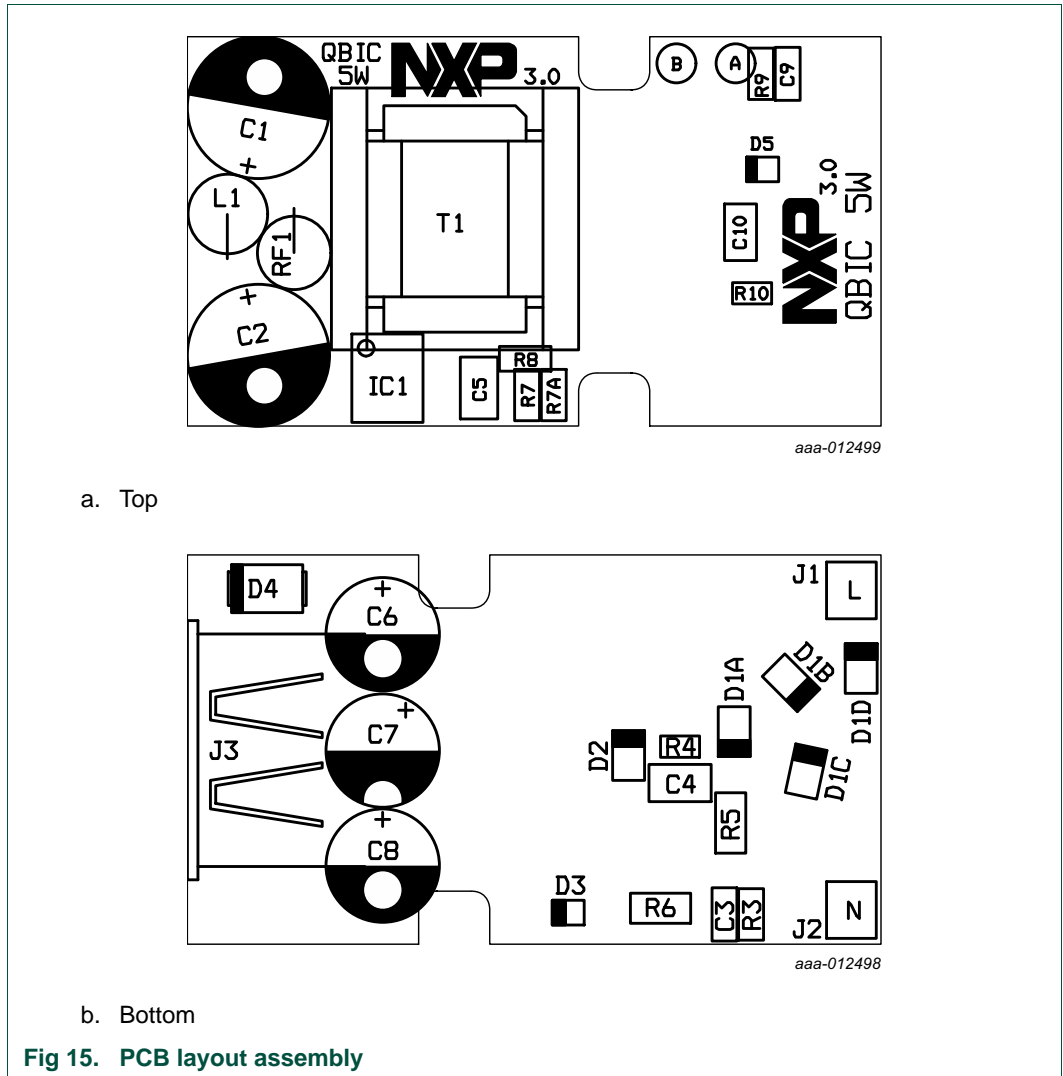
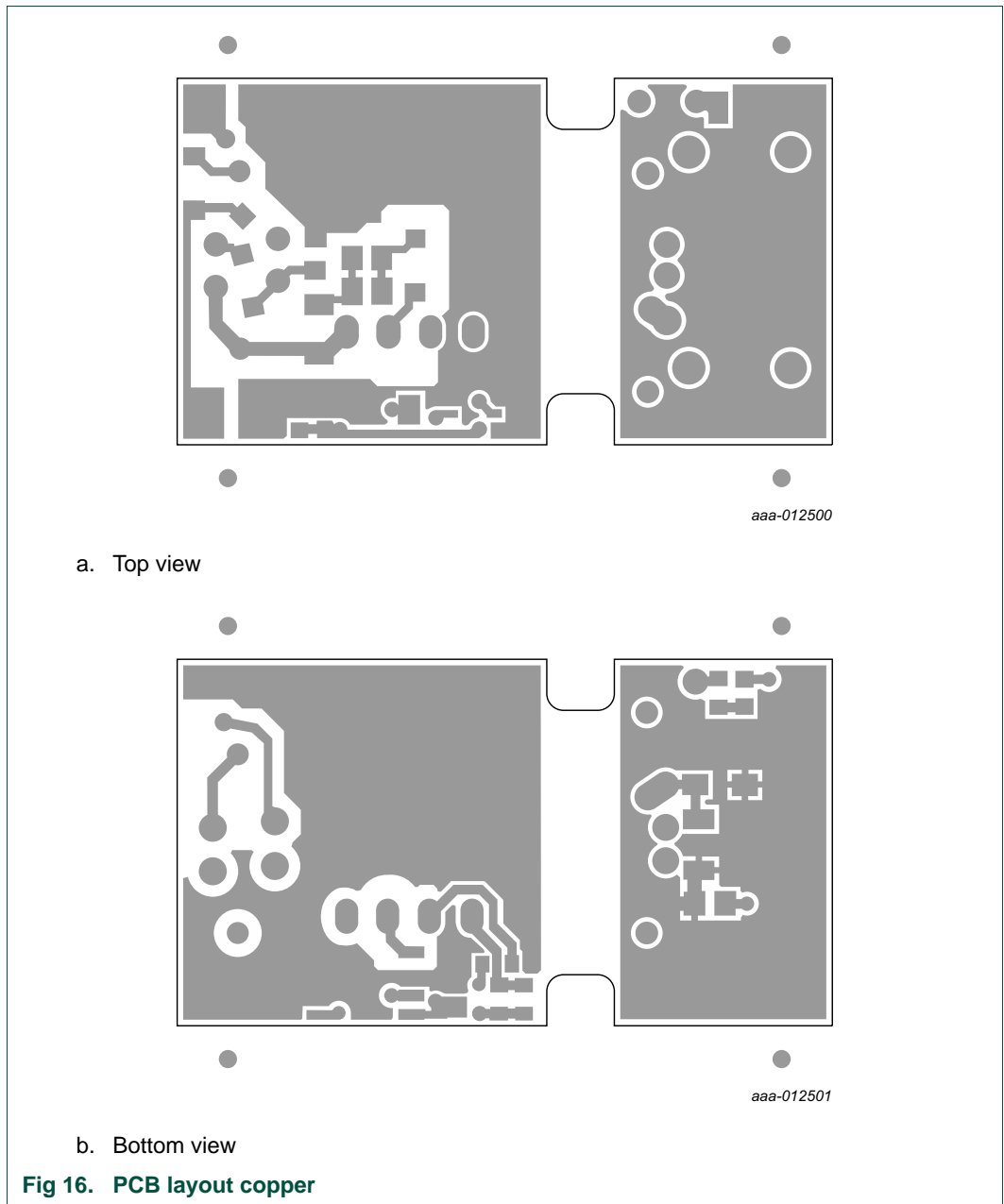


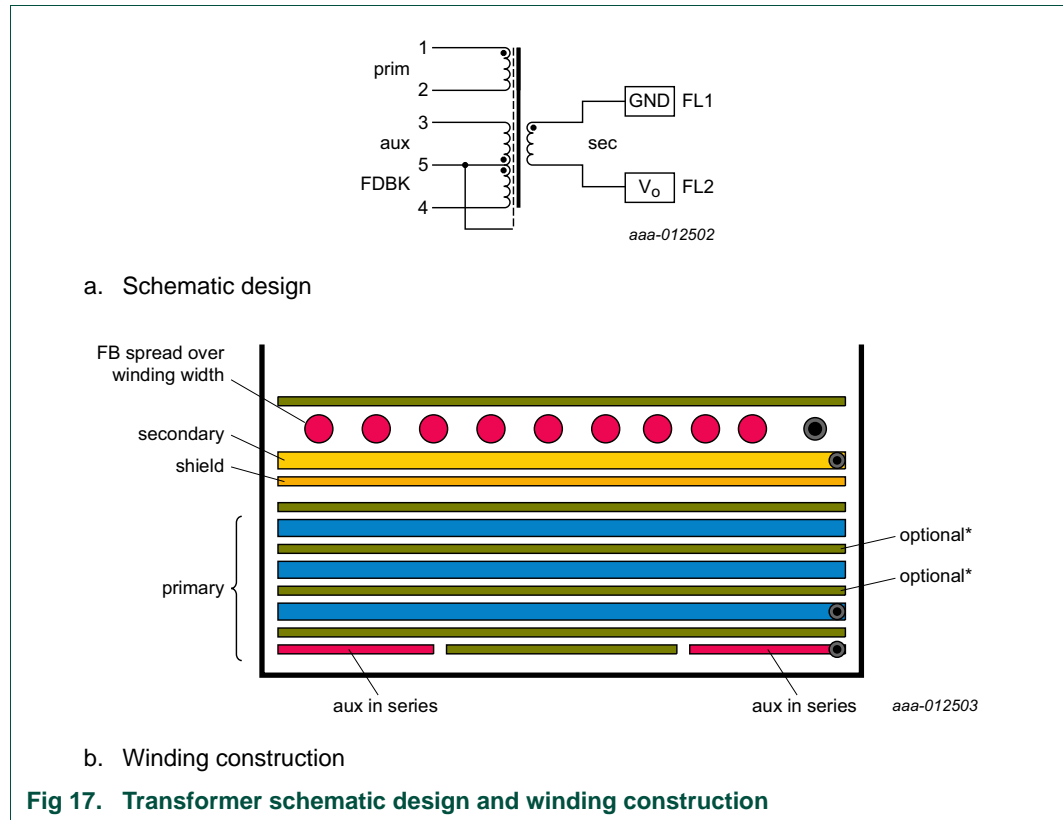
Fig 15. PCB layout assembly



## 11. Transformer specifications

### 11.1 Transformer schematic design and winding construction

The transformer used in the small-size demo board has size EPC13 with bobbin EPC13 horizontal 10 pins. A few measures have been taken for a low EMI emission. Copper foil shields are used between primary windings and secondary windings.



### 11.2 Winding specification

Table 5. Winding specification

Layer no.	Type	Wire Ø (mm)	Turns	No. of layers	Method	Start	Finish
1	aux	0.1	12 × 2	1	split	pin 5	pin 3
2	tape	-	1	-	-	-	-
3	prim	0.1	165	3	close	pin 1	pin 2
4	tape	-	2	-	-	-	-
5	shield	0.025 · CuSn6	1	-	-	pin 5	-
6	sec	0.4 TIW	11	1	close	fly 1	fly 2
7	FDBK	0.1	10	1	spread	pin 5	pin 4
8	tape	-	-	-	-	-	-

11.3 Electrical characteristics

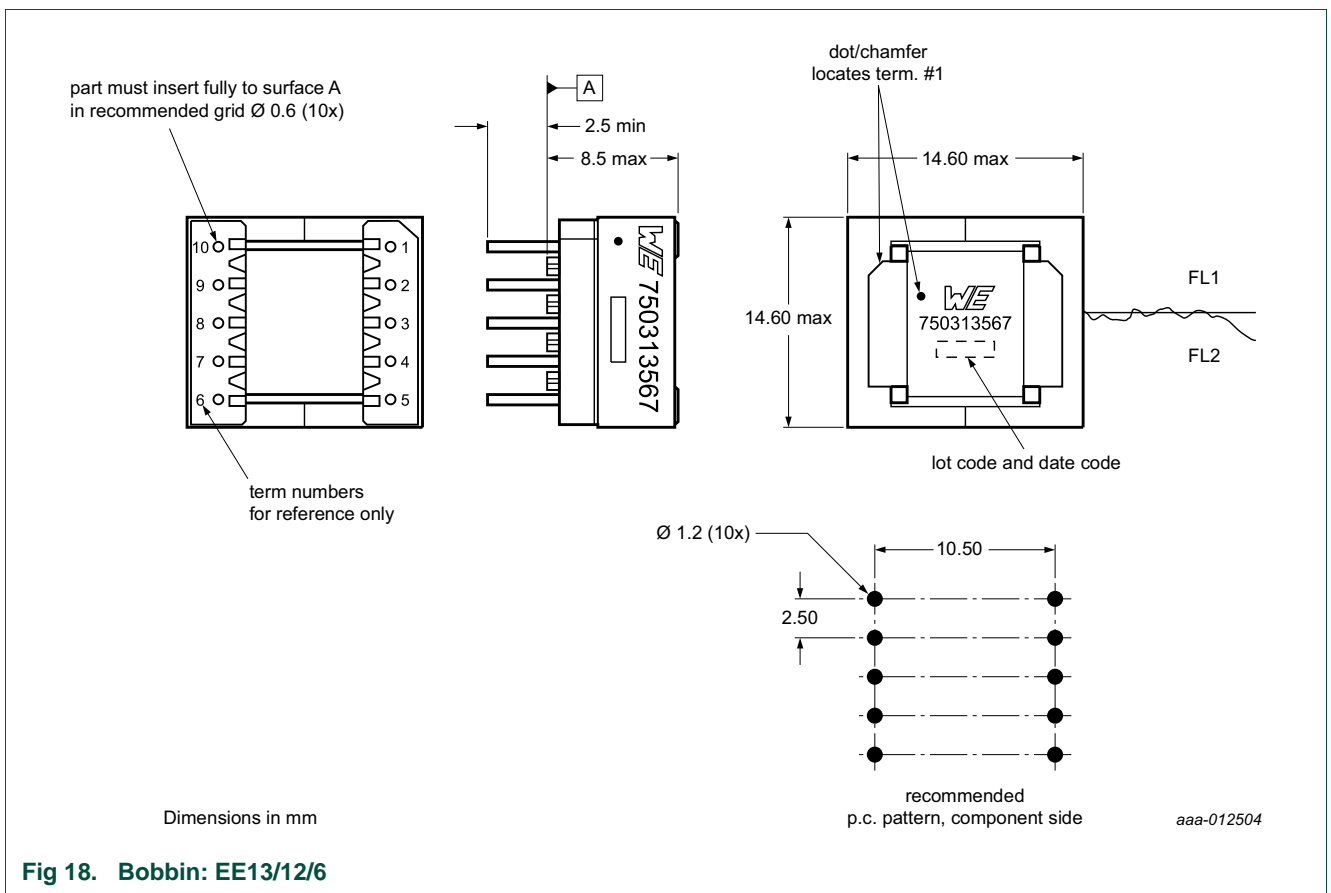
Table 6. Electrical specification

Parameter	Pin	Value	Remark
primary inductance	1 to 2	1.85 mH, ±10 %	
Leakage inductance	1 to 2	75 µH	all other windings short circuit

11.4 Core and bobbin

Core: EPC13. Core material: TP4/TP4A, equivalent to PC44

Bobbin: Würth Elektronik, EPC13 horizontal 10 pins, part number 070-5483



11.5 Marking

Würth/Midcom 750313567

## 12. Attention points

---

When testing the CC mode of the TEA1721AT, use an electronic DC-load in resistive mode, not in current mode.

The current in CC mode has a small fold back characteristic (see [Figure 5](#)). When the current mode of an electronic DC-load is used, the output voltage drops immediate to zero when the maximum current is exceeded. Once the output voltage and the input voltage of the DC-load is zero, many DC-loads cannot adjust the current. Using the resistive mode of the electronic DC-load avoids this problem.

**Remark:** This TEA1721AT controller behavior is not incorrect. Only test it in the correct way.



## 13. References

---

- [1] **TEA1721AT** — data sheet: ultra-low standby SMPS controller with integrated power switch
- [2] **AN11060** — Application note: TEA172X 5 W to 11 W power supply/usb charger
- [3] **AN11029** — Application note: Using TEA1721/TEA1723 ultra-low standby SMPS controller ICs in white goods applications
- [4] **UM10520** — TEA1721 Isolated 3-phase universal mains flyback converter demo board user manual
- [5] **UM10521** — TEA1721 isolated universal mains flyback converter demo board user manual
- [6] **UM10522** — TEA1721 non-isolated universal mains buck and buck/boost converter demo board user manual
- [7] **UM10523** — TEA1721 universal mains white goods flyback SMPS demo board user manual
- [8] **UM10529** — TEA1721AT 5 W GreenChip SP small-size demo board
- [9] **UM10532** — TEA1723AT GreenChip SP low standby power SMPS demo board

## 14. Legal information

### 14.1 Definitions

**Draft** — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

### 14.2 Disclaimers

**Limited warranty and liability** — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

**Right to make changes** — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

**Suitability for use** — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

**Evaluation products** — This product is provided on an "as is" and "with all faults" basis for evaluation purposes only. NXP Semiconductors, its affiliates and their suppliers expressly disclaim all warranties, whether express, implied or statutory, including but not limited to the implied warranties of non-infringement, merchantability and fitness for a particular purpose. The entire risk as to the quality, or arising out of the use or performance, of this product remains with customer.

In no event shall NXP Semiconductors, its affiliates or their suppliers be liable to customer for any special, indirect, consequential, punitive or incidental damages (including without limitation damages for loss of business, business interruption, loss of use, loss of data or information, and the like) arising out of the use of or inability to use the product, whether or not based on tort (including negligence), strict liability, breach of contract, breach of warranty or any other theory, even if advised of the possibility of such damages.

Notwithstanding any damages that customer might incur for any reason whatsoever (including without limitation, all damages referenced above and all direct or general damages), the entire liability of NXP Semiconductors, its affiliates and their suppliers and customer's exclusive remedy for all of the foregoing shall be limited to actual damages incurred by customer based on reasonable reliance up to the greater of the amount actually paid by customer for the product or five dollars (US\$5.00). The foregoing limitations, exclusions and disclaimers shall apply to the maximum extent permitted by applicable law, even if any remedy fails of its essential purpose.

**Safety of high-voltage evaluation products** — The non-insulated high voltages that are present when operating this product, constitute a risk of electric shock, personal injury, death and/or ignition of fire. This product is intended for evaluation purposes only. It shall be operated in a designated test area by personnel that is qualified according to local requirements and labor laws to work with non-insulated mains voltages and high-voltage circuits.

The product does not comply with IEC 60950 based national or regional safety standards. NXP Semiconductors does not accept any liability for damages incurred due to inappropriate use of this product or related to non-insulated high voltages. Any use of this product is at customer's own risk and liability. The customer shall fully indemnify and hold harmless NXP Semiconductors from any liability, damages and claims resulting from the use of the product.

**Translations** — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

### 14.3 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

**GreenChip** — is a trademark of NXP Semiconductors N.V.

## 15. Contents

<b>1</b>	<b>Introduction</b> .....	<b>3</b>
<b>2</b>	<b>Safety warning</b> .....	<b>3</b>
<b>3</b>	<b>Features</b> .....	<b>4</b>
<b>4</b>	<b>Technical specification</b> .....	<b>4</b>
<b>5</b>	<b>Board photograph</b> .....	<b>5</b>
<b>6</b>	<b>Performance</b> .....	<b>6</b>
6.1	No-load input power dissipation .....	6
6.2	Output voltage and efficiency performance data	6
6.3	Dynamic loading from 0 A to 0.5 A .....	9
6.4	Dynamic loading from 0.5 A to 0 A .....	10
6.5	Short-circuit of the output .....	11
6.6	Output voltage ripple performance .....	13
6.7	Conducted EMI measurement results .....	15
<b>7</b>	<b>Schematic</b> .....	<b>17</b>
<b>8</b>	<b>Bill of Materials (BOM)</b> .....	<b>18</b>
<b>9</b>	<b>Circuit description</b> .....	<b>19</b>
9.1	Rectification section .....	19
9.2	Filtering section .....	19
9.3	GreenChip SP section .....	19
9.4	Output section .....	19
9.5	Feedback section .....	19
<b>10</b>	<b>PCB layout</b> .....	<b>20</b>
<b>11</b>	<b>Transformer specifications</b> .....	<b>22</b>
11.1	Transformer schematic design and winding construction .....	22
11.2	Winding specification .....	22
11.3	Electrical characteristics .....	23
11.4	Core and bobbin .....	23
11.5	Marking .....	23
<b>12</b>	<b>Attention points</b> .....	<b>24</b>
<b>13</b>	<b>References</b> .....	<b>25</b>
<b>14</b>	<b>Legal information</b> .....	<b>26</b>
14.1	Definitions .....	26
14.2	Disclaimers .....	26
14.3	Trademarks .....	26
<b>15</b>	<b>Contents</b> .....	<b>27</b>

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP Semiconductors N.V. 2014. All rights reserved.

For more information, please visit: <http://www.nxp.com>  
 For sales office addresses, please send an email to: [salesaddresses@nxp.com](mailto:salesaddresses@nxp.com)

Date of release: 7 May 2014  
 Document identifier: UM10780

## X-ON Electronics

Largest Supplier of Electrical and Electronic Components

*Click to view similar products for [Power Management IC Development Tools](#) category:*

*Click to view products by [NXP](#) manufacturer:*

Other Similar products are found below :

[EVAL-ADM1168LQEBZ](#) [EVB-EP5348UI](#) [MIC23451-AAAYFL EV](#) [MIC5281YMME EV](#) [DA9063-EVAL](#) [ADP122-3.3-EVALZ](#) [ADP130-0.8-EVALZ](#) [ADP130-1.2-EVALZ](#) [ADP130-1.5-EVALZ](#) [ADP130-1.8-EVALZ](#) [ADP1712-3.3-EVALZ](#) [ADP1714-3.3-EVALZ](#) [ADP1715-3.3-EVALZ](#) [ADP1716-2.5-EVALZ](#) [ADP1740-1.5-EVALZ](#) [ADP1752-1.5-EVALZ](#) [ADP1828LC-EVALZ](#) [ADP1870-0.3-EVALZ](#) [ADP1871-0.6-EVALZ](#) [ADP1873-0.6-EVALZ](#) [ADP1874-0.3-EVALZ](#) [ADP1882-1.0-EVALZ](#) [ADP199CB-EVALZ](#) [ADP2102-1.25-EVALZ](#) [ADP2102-1.875EVALZ](#) [ADP2102-1.8-EVALZ](#) [ADP2102-2-EVALZ](#) [ADP2102-3-EVALZ](#) [ADP2102-4-EVALZ](#) [ADP2106-1.8-EVALZ](#) [ADP2147CB-110EVALZ](#) [AS3606-DB](#) [BQ24010EVM](#) [BQ24075TEVM](#) [BQ24155EVM](#) [BQ24157EVM-697](#) [BQ24160EVM-742](#) [BQ24296MEVM-655](#) [BQ25010EVM](#) [BQ3055EVM](#) [NCV891330PD50GEVB](#) [ISLUSBI2CKIT1Z](#) [LM2744EVAL](#) [LM2854EVAL](#) [LM3658SD-AEV/NOPB](#) [LM3658SDEV/NOPB](#) [LM3691TL-1.8EV/NOPB](#) [LM4510SDEV/NOPB](#) [LM5033SD-EVAL](#) [LP38512TS-1.8EV](#)